

Title (en)  
COMPOSITE BODIES, METHOD FOR THE PRODUCTION THEREOF AND USE THEREOF

Title (de)  
VERBUNDK RPER, VERFAHREN ZU DESSEN HERSTELLUNG UND DESSEN VE RWENDUNG

Title (fr)  
CORPS COMPOSITE, PROCEDE DE REALISATION ET SON UTILISATION

Publication  
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Application  
**EP 04804159 A 20041222**

Priority  
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Abstract (en)  
[origin: WO2005065943A1] The invention relates to composite bodies containing polyacetal and at least one thermoplastic polyamide elastomer formed by a polyacetal moulded part which is partially or fully coated with the thermoplastic polyamide elastomer or on which one or several moulded parts are directly formed from the thermoplastic polyamide elastomer. The composite bodies are characterized in that the polyacetal and the thermoplastic polyamide elastomer are bonded to each other by adhesively or cohesively spraying the polyamide elastomer onto the polyacetal moulded part and also in that the composite resistance at a tractive stress between the polyacetal and the thermoplastic polyamide elastomer is at least 0.5 N/mm<2>. The composite bodies can be used as linking elements, functional parts with integrated sealing and damping properties and non-slip, handle-friendly elements.

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